

## ACEPACK™ 1 converter inverter brake, 1200 V, 15 A trench gate field-stop IGBT M series, soft diode and NTC

Datasheet - production data

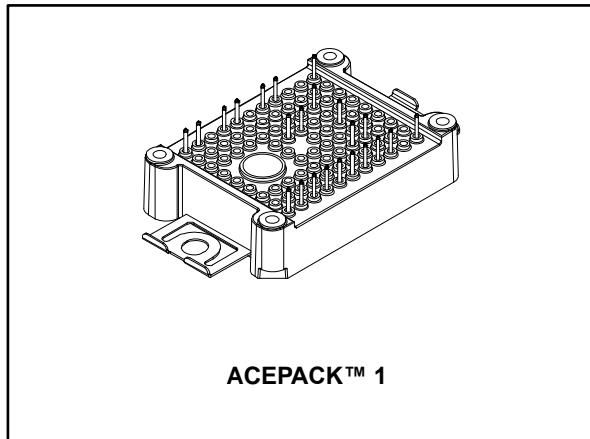
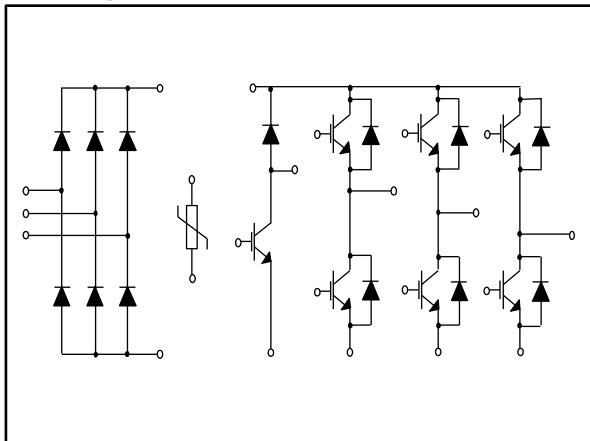


Figure 1: Internal electrical schematic



### Features

- ACEPACK™ 1 power module
  - DBC Cu Al<sub>2</sub>O<sub>3</sub> Cu
- Converter inverter brake topology
  - 1600 V, very low drop rectifiers for converter
  - 1200 V, 15 A IGBTs and diodes
  - $V_{CE(sat)}$ : 1.95 V @  $I_C = 15$  A
  - Soft and fast recovery diode
- Integrated NTC

### Applications

- Inverters
- Motor drives

### Description

This power module is a converter-inverter brake (CIB) topology in an ACEPACK™ 1 package with NTC, integrating the advanced trench gate field-stop technology from STMicroelectronics. This new IGBT technology represents the best compromise between conduction and switching loss, to maximize the efficiency of any converter system up to 20 kHz.

Table 1: Device summary

| Order code | Marking    | Package    | Leads type          |
|------------|------------|------------|---------------------|
| A1C15S12M3 | A1C15S12M3 | ACEPACK™ 1 | Solder contact pins |

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# 1 Electrical ratings

## 1.1 Inverter stage

Limiting values at  $T_j = 25\text{ °C}$ , unless otherwise specified.

### 1.1.1 IGBTs

**Table 2: Absolute maximum ratings of the IGBTs, inverter stage**

| Symbol         | Description   | Value      | Unit |
|----------------|---|------------|------|
| $V_{CES}$      | Collector-emitter voltage ( $V_{GE} = 0$ )                  | 1200       | V    |
| $I_C$          | Continuous collector current at $T_c = 100\text{ °C}$       | 15         | A    |
| $I_{CP}^{(1)}$ | Pulsed collector current ( $t_P = 1\text{ ms}$ )            | 30         | A    |
| $V_{GE}$       | Gate-emitter voltage  | $\pm 20$   | V    |
| $P_{TOT}$      | Total power dissipation IGBT ( $T_{JMAX} = 175\text{ °C}$ ) | 142.8      | W    |
| $T_{JMAX}$     | Maximum junction temperature                                | 175        | °C   |
| $T_{Jop}$      | Operative temperature range under switching conditions      | -40 to 150 | °C   |

**Notes:**

<sup>(1)</sup>Pulse width limited by maximum junction temperature.

**Table 3: Electrical characteristics of the IGBTs, inverter stage**

| Symbol         | Parameter                            | Test conditions  | Min. | Typ. | Max.      | Unit          |
|----------------|--------------------------------------|--|------|------|-----------|---------------|
| $V_{(BR)CES}$  | Collector-emitter breakdown voltage  | $I_C = 1\text{ mA}$ , $V_{GE} = 0\text{ V}$  | 1200 |      |           | V             |
| $V_{CE(sat)}$  | Collector-emitter saturation voltage | $V_{GE} = 15\text{ V}$ , $I_C = 15\text{ A}$   |      | 1.95 | 2.45      | V             |
|                |                                      | $V_{GE} = 15\text{ V}$ ,<br>$I_C = 15\text{ A}$ ,<br>$T_J = 150\text{ °C}$   |      | 2.3  |           | V             |
| $V_{GE(th)}$   | Gate threshold voltage               | $V_{CE} = V_{GE}$ , $I_C = 1\text{ mA}$  | 5    | 6    | 7         | V             |
| $I_{CES}$      | Collector cut-off current            | $V_{GE} = 0\text{ V}$ , $V_{CE} = 1200\text{ V}$   |      |      | 100       | $\mu\text{A}$ |
| $I_{GES}$      | Gate-emitter leakage current         | $V_{CE} = 0\text{ V}$ , $V_{GE} = \pm 20\text{ V}$   |      |      | $\pm 500$ | nA            |
| $C_{ies}$      | Input capacitance                    | $V_{CE} = 25\text{ V}$ , $f = 1\text{ MHz}$ ,<br>$V_{GE} = 0\text{ V}$   |      | 985  |           | pF            |
| $C_{oes}$      | Output capacitance                   |  |      | 118  |           | pF            |
| $C_{res}$      | Reverse transfer capacitance         |  |      | 40   |           | pF            |
| $Q_g$          | Total gate charge                    | $V_{CC} = 960\text{ V}$ , $I_C = 15\text{ A}$ ,<br>$V_{GE} = \pm 15\text{ V}$  |      | 71   |           | nC            |
| $t_{d(on)}$    | Turn-on delay time                   | $V_{CC} = 600\text{ V}$ , $I_C = 15\text{ A}$ ,<br>$R_G = 22\ \Omega$ , $V_{GE} = \pm 15\text{ V}$ ,<br>$di/dt = 820\text{ A}/\mu\text{s}$ |      | 120  |           | ns            |
| $t_r$          | Current rise time                    |  |      | 14.5 |           | ns            |
| $E_{on}^{(1)}$ | Turn-on switching energy             |  |      |      | 0.59      |               |

| Symbol          | Parameter                           | Test conditions   | Min. | Typ. | Max. | Unit                      |
|-----------------|-------------------------------------|---|------|------|------|---------------------------|
| $t_{d(off)}$    | Turn-off delay time                 | $V_{CC} = 600\text{ V}$ , $I_C = 15\text{ A}$ ,<br>$R_G = 22\ \Omega$ , $V_{GE} = \pm 15\text{ V}$ ,<br>$dv/dt = 8200\text{ V}/\mu\text{s}$ ;                                   |      | 115  |      | ns                        |
| $t_f$           | Current fall time                   |   |      | 84   |      | ns                        |
| $E_{off}^{(2)}$ | Turn-off switching energy           |   |      | 0.83 |      | mJ                        |
| $t_{d(on)}$     | Turn-on delay time                  | $V_{CC} = 600\text{ V}$ , $I_C = 15\text{ A}$ ,<br>$R_G = 22\ \Omega$ , $V_{GE} = \pm 15\text{ V}$ ,<br>$di/dt = 690\text{ A}/\mu\text{s}$ , $T_J = 150\text{ }^\circ\text{C}$  |      | 122  |      | ns                        |
| $t_r$           | Current rise time                   |   |      | 17   |      | ns                        |
| $E_{on}^{(1)}$  | Turn-on switching energy            |   |      | 1.08 |      | mJ                        |
| $t_{d(off)}$    | Turn-off delay time                 | $V_{CC} = 600\text{ V}$ , $I_C = 15\text{ A}$ ,<br>$R_G = 22\ \Omega$ , $V_{GE} = \pm 15\text{ V}$ ,<br>$dv/dt = 7000\text{ V}/\mu\text{s}$ , $T_J = 150\text{ }^\circ\text{C}$ |      | 122  |      | ns                        |
| $t_f$           | Current fall time                   |   |      | 146  |      | ns                        |
| $E_{off}^{(2)}$ | Turn-off switching energy           |   |      | 1.06 |      | mJ                        |
| $t_{SC}$        | Short-circuit withstand time        | $V_{CC} \leq 600\text{ V}$ , $V_{GE} \leq 15\text{ V}$ ,<br>$T_{Jstart} \leq 150\text{ }^\circ\text{C}$   | 10   |      |      | $\mu\text{s}$             |
| $R_{THj-c}$     | Thermal resistance junction to case | each IGBT   |      | 0.95 | 1.05 | $^\circ\text{C}/\text{W}$ |
| $R_{THc-h}$     | Thermal resistance case to heatsink | each IGBT,<br>$\lambda_{grease} = 1\text{ W}/(\text{m}\cdot^\circ\text{C})$   |      | 0.90 |      | $^\circ\text{C}/\text{W}$ |

**Notes:**

(1) Including the reverse recovery of the diode.

(2) Including also the tail of the collector current.

**1.1.2 Diode**Limiting values at  $T_J = 25\text{ }^\circ\text{C}$ , unless otherwise specified.**Table 4: Absolute maximum ratings of the diode, inverter stage**

| Symbol         | Parameter   | Value      | Unit             |
|----------------|---|------------|------------------|
| $V_{RRM}$      | Repetitive peak reverse voltage                                     | 1200       | V                |
| $I_F$          | Continuous forward current at ( $T_C = 100\text{ }^\circ\text{C}$ ) | 15         | A                |
| $I_{FF}^{(1)}$ | Pulsed forward current  | 30         | A                |
| $T_{JMAX}$     | Maximum junction temperature  | 175        | $^\circ\text{C}$ |
| $T_{Jop}$      | Operative temperature range under switching conditions              | -40 to 150 | $^\circ\text{C}$ |

**Notes:**

(1) Pulse width limited by maximum junction temperature.

Table 5: Electrical characteristics of the diode, inverter stage

| Symbol             | Parameter                           | Test conditions  | Min. | Typ. | Max. | Unit |
|--------------------|-------------------------------------|--|------|------|------|------|
| V <sub>F</sub>     | Forward voltage                     | I <sub>F</sub> = 15 A  | -    | 3.0  | 3.8  | V    |
|                    |                                     | I <sub>F</sub> = 15 A, T <sub>J</sub> = 150 °C   | -    | 2.1  |      |      |
| t <sub>rr</sub>    | Reverse recovery time               | I <sub>F</sub> = 15 A, V <sub>R</sub> = 600 V,<br>V <sub>GE</sub> = ±15 V,<br>di <sub>F</sub> /dt = 820 A/μs                             | -    | 190  |      | ns   |
| Q <sub>rr</sub>    | Reverse recovery charge             |  | -    | 1.45 |      | μC   |
| I <sub>rrm</sub>   | Reverse recovery current            |  | -    | 23   |      | A    |
| E <sub>rec</sub>   | Reverse recovery energy             |  | -    | 0.55 |      | mJ   |
| t <sub>rr</sub>    | Reverse recovery time               | I <sub>F</sub> = 15 A, V <sub>R</sub> = 600 V,<br>V <sub>GE</sub> = ±15 V,<br>di <sub>F</sub> /dt = 690 A/μs,<br>T <sub>J</sub> = 150 °C | -    | 400  |      | ns   |
| Q <sub>rr</sub>    | Reverse recovery charge             |  | -    | 2.75 |      | μC   |
| I <sub>rrm</sub>   | Reverse recovery current            |  | -    | 25   |      | A    |
| E <sub>rec</sub>   | Reverse recovery energy             |  | -    | 1.2  |      | mJ   |
| R <sub>THj-c</sub> | Thermal resistance junction to case | Each diode   | -    | 1.60 | 1.75 | °C/W |
| R <sub>THc-h</sub> | Thermal resistance case to heatsink | Each diode,<br>λ <sub>grease</sub> = 1 W/(m·°C)  | -    | 1.15 |      | °C/W |

## 1.2 Brake stage

Limiting values at T<sub>j</sub> = 25 °C, unless otherwise specified.

### 1.2.1 IGBT

Table 6: Absolute maximum ratings of the IGBT, brake stage

| Symbol                         | Parameter  | Value      | Unit |
|--------------------------------|--|------------|------|
| V <sub>CES</sub>               | Collector-emitter voltage (V <sub>GE</sub> = 0)        | 1200       | V    |
| I <sub>c</sub>                 | Continuous collector current (T <sub>c</sub> = 100 °C) | 15         | A    |
| I <sub>CP</sub> <sup>(1)</sup> | Pulsed collector current                               | 30         | A    |
| V <sub>GE</sub>                | Gate-emitter voltage                                   | ±20        | V    |
| P <sub>TOT</sub>               | Total power dissipation                                | 142.8      | W    |
| T <sub>JMAX</sub>              | Maximum junction temperature                           | 175        | °C   |
| T <sub>Jop</sub>               | Operative temperature range under switching conditions | -40 to 150 | °C   |

**Notes:**

<sup>(1)</sup>Pulse width limited by maximum junction temperature.

Table 7: Electrical characteristics of the IGBT, brake stage

| Symbol        | Parameter                            | Test conditions  | Min. | Typ. | Max.      | Unit                        |
|---------------|--------------------------------------|--|------|------|-----------|-----------------------------|
| $V_{(BR)CES}$ | Collector-emitter breakdown voltage  | $I_C = 1 \text{ mA}$ , $V_{GE} = 0 \text{ V}$  | 1200 |      |           | V                           |
| $V_{CE(sat)}$ | Collector-emitter saturation voltage | $V_{GE} = 15 \text{ V}$ , $I_C = 15 \text{ A}$   |      | 1.95 | 2.45      | V                           |
|               |                                      | $V_{GE} = 15 \text{ V}$ , $I_C = 15 \text{ A}$ ,<br>$T_J = 150 \text{ °C}$   |      | 2.3  |           |                             |
| $V_{GE(th)}$  | Gate threshold voltage               | $V_{CE} = V_{GE}$ , $I_C = 1 \text{ mA}$   | 5    | 6    | 7         | V                           |
| $I_{CES}$     | Collector cut-off current            | $V_{GE} = 0 \text{ V}$ , $V_{CE} = 1200 \text{ V}$   |      |      | 100       | $\mu\text{A}$               |
| $I_{GES}$     | Gate-emitter leakage current         | $V_{CE} = 0 \text{ V}$ , $V_{GE} = \pm 20 \text{ V}$   |      |      | $\pm 500$ | nA                          |
| $C_{ies}$     | Input capacitance                    | $V_{CE} = 25 \text{ V}$ , $f = 1 \text{ MHz}$ ,<br>$V_{GE} = 0 \text{ V}$  |      | 985  |           | pF                          |
| $C_{oes}$     | Output capacitance                   |  |      | 118  |           | pF                          |
| $C_{res}$     | Reverse transfer capacitance         |  |      | 40   |           | pF                          |
| $Q_g$         | Total gate charge                    | $V_{CC} = 960 \text{ V}$ , $I_C = 15 \text{ A}$ ,<br>$V_{GE} = \pm 15 \text{ V}$   |      | 71   |           | nC                          |
| $t_{d(on)}$   | Turn-on delay time                   | $V_{CC} = 600 \text{ V}$ , $I_C = 15 \text{ A}$ ,<br>$R_G = 22 \text{ }\Omega$ ,<br>$V_{GE} = \pm 15 \text{ V}$ ,<br>$di/dt = 820 \text{ A}/\mu\text{s}$                           |      | 120  |           | ns                          |
| $t_r$         | Current rise time                    |  |      | 14.5 |           | ns                          |
| $E_{on(1)}$   | Turn-on switching energy             |  |      | 0.59 |           | mJ                          |
| $t_{d(off)}$  | Turn-off delay time                  | $V_{CC} = 600 \text{ V}$ , $I_C = 15 \text{ A}$ ,<br>$R_G = 22 \text{ }\Omega$ ,<br>$V_{GE} = \pm 15 \text{ V}$ ,<br>$dv/dt = 8200 \text{ V}/\mu\text{s}$ ;                        |      | 115  |           | ns                          |
| $t_f$         | Current fall time                    |  |      | 84   |           | ns                          |
| $E_{off(2)}$  | Turn-off switching energy            |  |      | 0.83 |           | mJ                          |
| $t_{d(on)}$   | Turn-on delay time                   | $V_{CC} = 600 \text{ V}$ , $I_C = 15 \text{ A}$ ,<br>$R_G = 22 \text{ }\Omega$ , $V_{GE} = \pm 15 \text{ V}$ ,<br>$di/dt = 690 \text{ A}/\mu\text{s}$ , $T_J = 150 \text{ °C}$     |      | 122  |           | ns                          |
| $t_r$         | Current rise time                    |  |      | 17   |           | ns                          |
| $E_{on}$      | Turn-on switching energy             |  |      | 1.08 |           | mJ                          |
| $t_{d(off)}$  | Turn-off delay time                  | $V_{CC} = 600 \text{ V}$ , $I_C = 15 \text{ A}$ ,<br>$R_G = 22 \text{ }\Omega$ , $V_{GE} = \pm 15 \text{ V}$ ,<br>$dv/dt = 7000 \text{ V}/\mu\text{s}$ ,<br>$T_J = 150 \text{ °C}$ |      | 122  |           | ns                          |
| $t_f$         | Current fall time                    |  |      | 146  |           | ns                          |
| $E_{off}$     | Turn-off switching energy            |  |      | 1.06 |           | mJ                          |
| $t_{SC}$      | Short-circuit withstand time         | $V_{CC} \leq 600 \text{ V}$ , $V_{GE} \leq 15 \text{ V}$ ,<br>$T_{Jstart} \leq 150 \text{ °C}$   | 10   |      |           | $\mu\text{s}$               |
| $R_{THj-c}$   | Thermal resistance junction to case  | Each IGBT  |      | 0.95 | 1.05      | $^{\circ}\text{C}/\text{W}$ |
| $R_{THc-h}$   | Thermal resistance case to heatsink  | Each IGBT,<br>$\lambda_{grease} = 1 \text{ W}/(\text{m}\cdot^{\circ}\text{C})$   |      | 0.90 |           | $^{\circ}\text{C}/\text{W}$ |

**Notes:**<sup>(1)</sup>Including the reverse recovery of the diode.<sup>(2)</sup>Including the tail of the collector current.

1.2.2 Diode

Table 8: Absolute maximum ratings of the diode, brake stage

| Symbol                         | Parameter   | Value      | Unit |
|--------------------------------|---|------------|------|
| V <sub>RRM</sub>               | Repetitive peak reverse voltage                         | 1200       | V    |
| I <sub>F</sub>                 | Continuous forward current at (T <sub>C</sub> = 100 °C) | 15         | A    |
| I <sub>FP</sub> <sup>(1)</sup> | Pulsed forward current                                  | 30         | A    |
| T <sub>JMAX</sub>              | Maximum junction temperature                            | 175        | °C   |
| T <sub>Jop</sub>               | Operative temperature range under switching conditions  | -40 to 150 | °C   |

Notes:

(1)Pulse width limited by maximum junction temperature.

Table 9: Electrical characteristics of the diode, brake stage

| Symbol             | Parameter                           | Test conditions   | Min.             | Typ.                     | Max. | Unit |  |    |
|--------------------|-------------------------------------|---|------------------|--------------------------|------|------|--|----|
| V <sub>F</sub>     | Forward voltage                     | I <sub>F</sub> = 15 A   | -                | 3.0                      | 3.8  | V    |  |    |
|                    |                                     | I <sub>F</sub> = 15 A, T <sub>J</sub> = 150 °C  | -                | 2.1                      |      |      |  |    |
| t <sub>rr</sub>    | Reverse recovery time               | I <sub>F</sub> = 15 A, V <sub>R</sub> = 600 V,<br>V <sub>GE</sub> = ±15 V, di/dt = 820 A/μs                             | -                | 190                      |      | ns   |  |    |
| Q <sub>rr</sub>    | Reverse recovery charge             |   | -                | 1.45                     |      | μC   |  |    |
| I <sub>rrm</sub>   | Reverse recovery current            |   | -                | 23                       |      | A    |  |    |
| E <sub>rec</sub>   | Reverse recovery energy             |   | -                | 0.55                     |      | mJ   |  |    |
| t <sub>rr</sub>    | Reverse recovery time               | I <sub>F</sub> = 15 A, V <sub>R</sub> = 600 V,<br>V <sub>GE</sub> = ±15 V, di/dt = 690 A/μs,<br>T <sub>J</sub> = 150 °C | -                | 400                      |      | ns   |  |    |
|                    |                                     |   | Q <sub>rr</sub>  | Reverse recovery charge  | -    | 2.75 |  | μC |
|                    |                                     |   | I <sub>rrm</sub> | Reverse recovery current | -    | 25   |  | A  |
|                    |                                     |   | E <sub>rec</sub> | Reverse recovery energy  | -    | 1.2  |  | mJ |
| R <sub>THj-c</sub> | Thermal resistance junction to case | Each diode  | -                | 1.60                     | 1.75 | °C/W |  |    |
| R <sub>THc-h</sub> | Thermal resistance case to heatsink | Each diode,<br>λ <sub>grease</sub> = 1 W/(m·°C)   | -                | 1.15                     |      | °C/W |  |    |

1.3 Converter stage

Limiting values at T<sub>j</sub> = 25 °C, unless otherwise specified.

Table 10: Absolute maximum ratings of the bridge rectifiers

| Symbol            | Description   | Value      | Unit             |
|-------------------|---|------------|------------------|
| V <sub>RRM</sub>  | Repetitive peak reverse voltage                           | 1600       | V                |
| I <sub>F</sub>    | RMS forward current                                       | 30         | A                |
| I <sub>FSM</sub>  | Forward surge current tp = 10 ms, T <sub>C</sub> = 25 °C  | 315        | A                |
|                   | Forward surge current tp = 10 ms, T <sub>C</sub> = 150 °C | 250        |                  |
| I <sup>2</sup> t  | tp = 10 ms, T <sub>C</sub> = 25 °C                        | 496        | A <sup>2</sup> s |
|                   | tp = 10 ms, T <sub>C</sub> = 150 °C                       | 312        |                  |
| T <sub>JMAX</sub> | Maximum junction temperature                              | 175        | °C               |
| T <sub>Jop</sub>  | Operative temperature range under switching conditions    | -40 to 150 | °C               |

Table 11: Electrical characteristics of the bridge rectifiers

| Symbol             | Parameter                           | Test conditions                                  | Min. | Typ. | Max. | Unit |
|--------------------|-------------------------------------|--|------|------|------|------|
| V <sub>F</sub>     | Forward voltage                     | I <sub>F</sub> = 15 A                            | -    | 1.0  | 1.4  | V    |
|                    |                                     | I <sub>F</sub> = 15 A, T <sub>J</sub> = 150 °C   | -    | 0.9  |      |      |
| I <sub>R</sub>     | Reverse current                     | T <sub>J</sub> = 150 °C, V <sub>R</sub> = 1600 V | -    | 1    |      | mA   |
| R <sub>THj-c</sub> | Thermal resistance junction to case | Each diode                                       | -    | 1.20 | 1.35 | °C/W |
| R <sub>THc-h</sub> | Thermal resistance case to heatsink | Each diode,<br>λ <sub>grease</sub> = 1 W/(m·°C)  | -    | 1.15 |      | °C/W |

## 1.4 NTC

Table 12: NTC temperature sensor, considered as stand-alone

| Symbol             | Parameter                     | Test condition | Min. | Typ. | Max. | Unit |
|--------------------|-------------------------------|----------------|------|------|------|------|
| R <sub>25</sub>    | Resistance                    | T = 25 °C      |      | 5    |      | kΩ   |
| R <sub>100</sub>   | Resistance                    | T = 100 °C     |      | 493  |      | Ω    |
| ΔR/R               | Deviation of R <sub>100</sub> |                | -5   |      | +5   | %    |
| B <sub>25/50</sub> | B-constant                    |                |      | 3375 |      | K    |
| B <sub>25/80</sub> | B-constant                    |                |      | 3411 |      | K    |
| T                  | Operating temperature range   |                | -40  |      | 150  | °C   |

Figure 2: NTC resistance vs. temperature

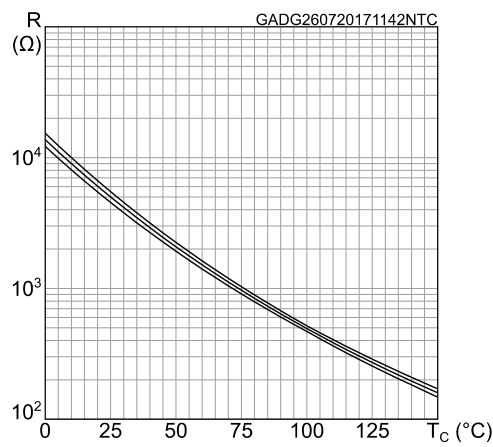
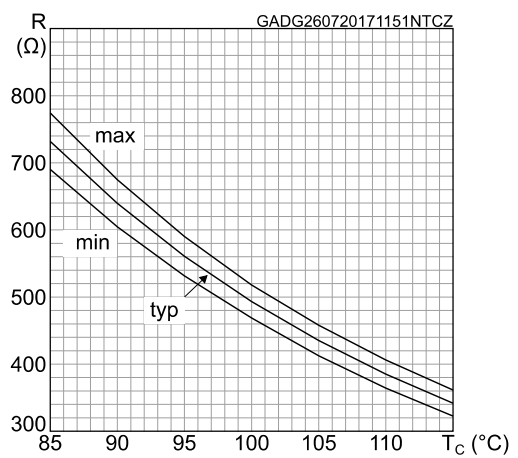


Figure 3: NTC resistance vs. temperature, zoom





## 1.5 Package

Table 13: ACEPACK™ 1 package

| Symbol     | Parameter                                  | Min. | Typ. | Max. | Unit |
|------------|--|------|------|------|------|
| $V_{isol}$ | Isolation voltage (AC voltage, $t = 60$ s) |      |      | 2500 | V    |
| $M_d$      | Screw mounting torque                      | 40   |      | 80   | Nm   |
| $T_{stg}$  | Storage temperature                        | -40  |      | 125  | °C   |
| CTI        | Comparative tracking index                 | 200  |      |      |      |
| $L_s$      | Stray inductance module P1 - EW loop       |      | 28.7 |      | nH   |
| $R_s$      | Module lead resistance, terminal to chip   |      | 3.9  |      | mΩ   |

## 2 Electrical characteristics curves

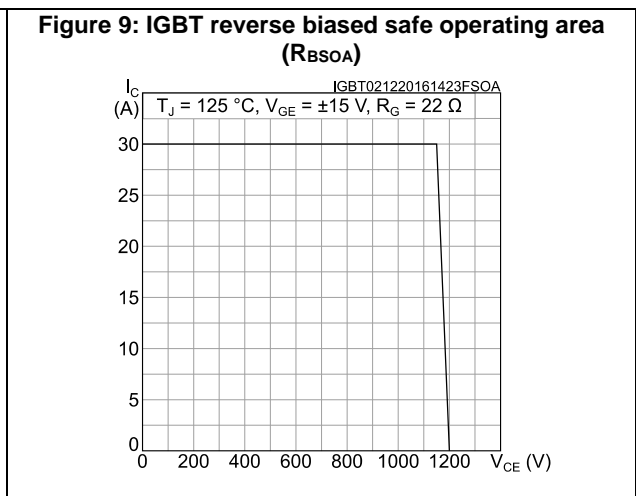
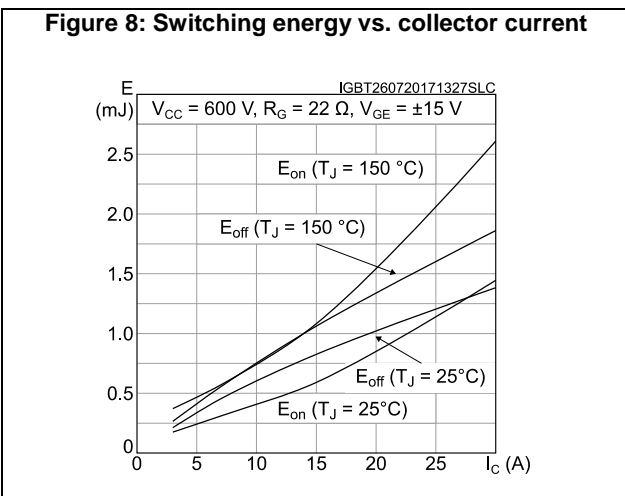
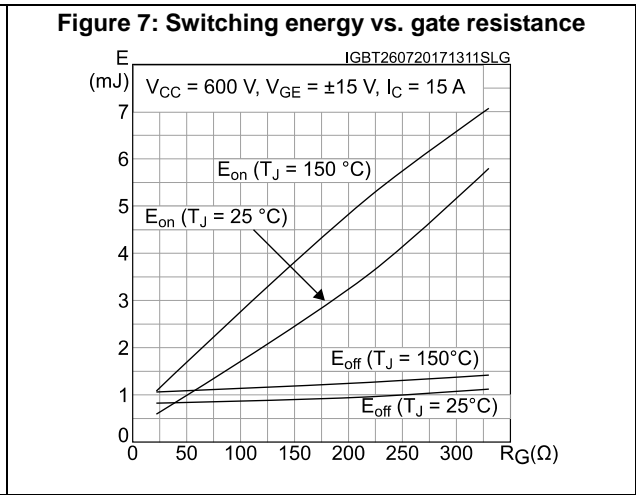
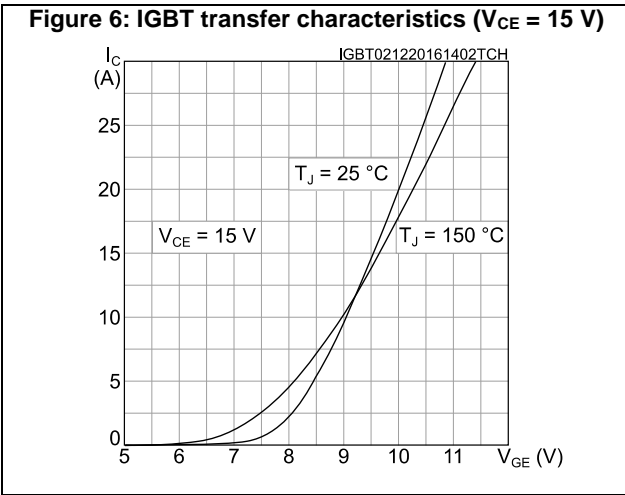
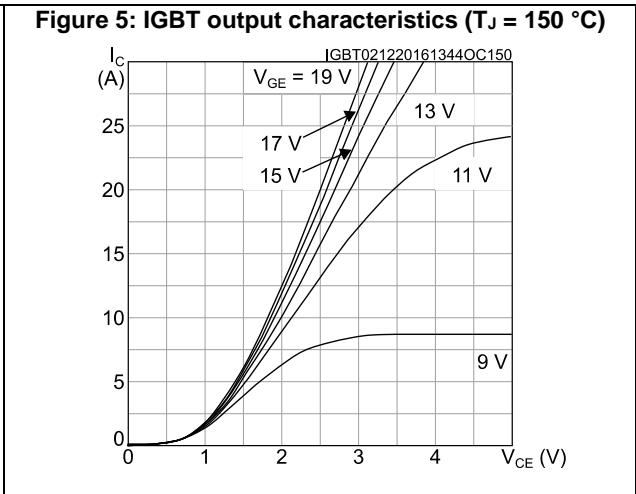
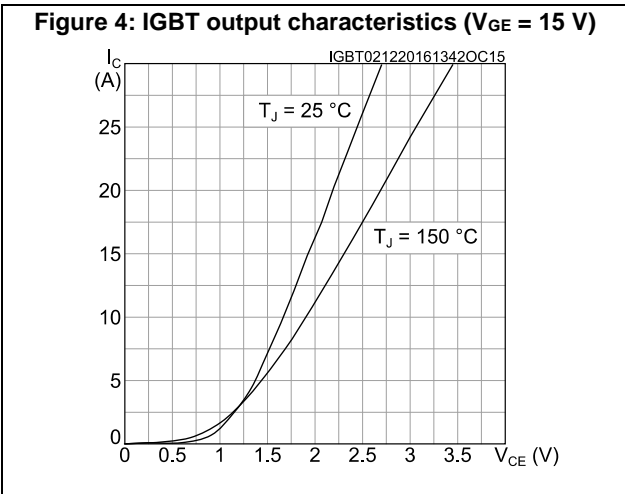


Figure 10: Diode forward characteristics

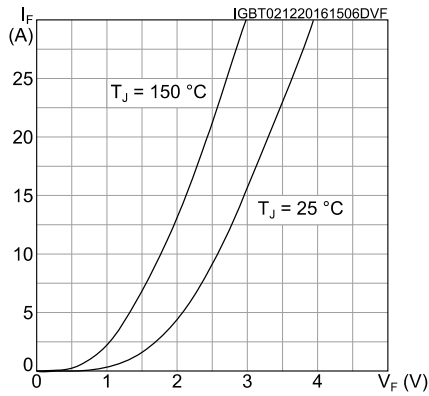


Figure 11: Diode reverse recovery energy vs. diode current slope

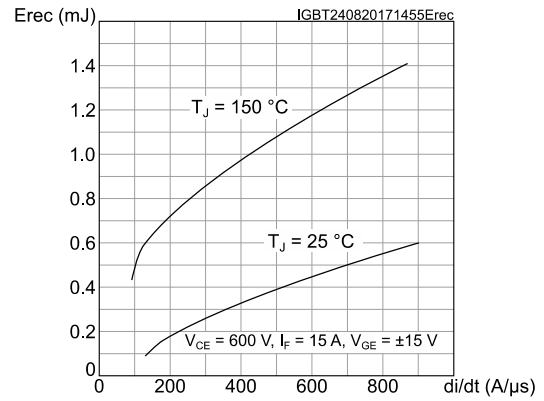


Figure 12: Diode reverse recovery energy vs. forward current

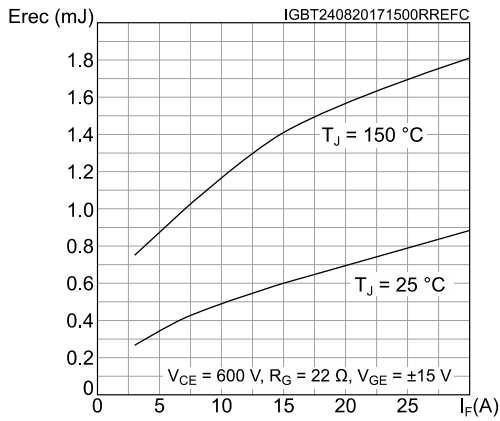


Figure 13: Diode reverse recovery energy vs. gate resistance

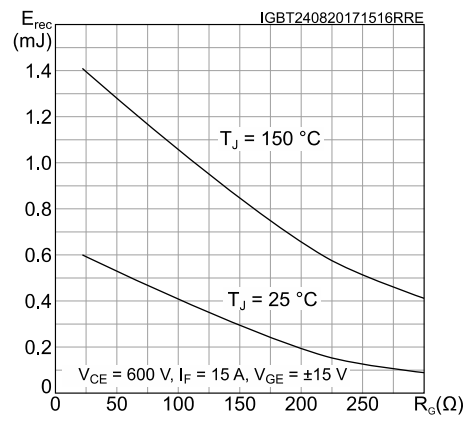


Figure 14: Converter diode forward characteristics

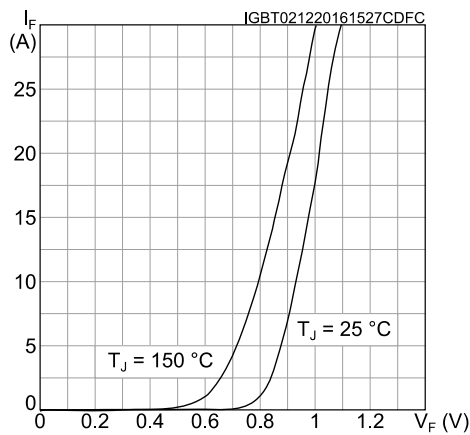


Figure 15: IGBT thermal impedance

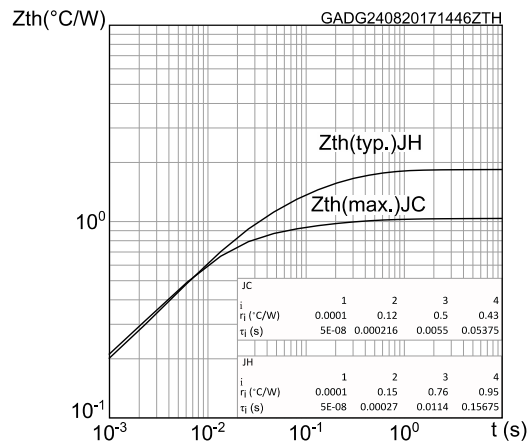
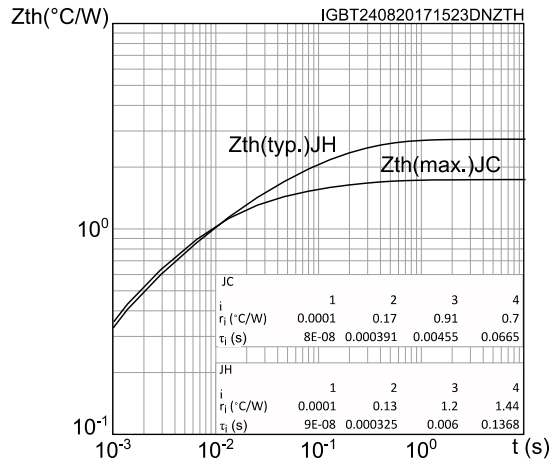


Figure 16: Inverter diode thermal impedance





# 4 Topology and pin description

Figure 21: Electrical topology and pin description

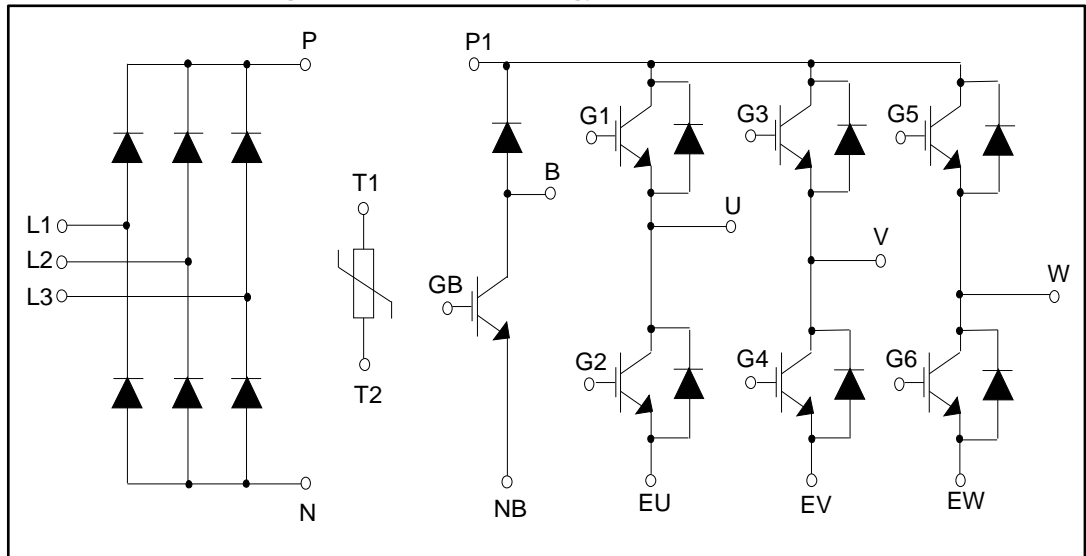
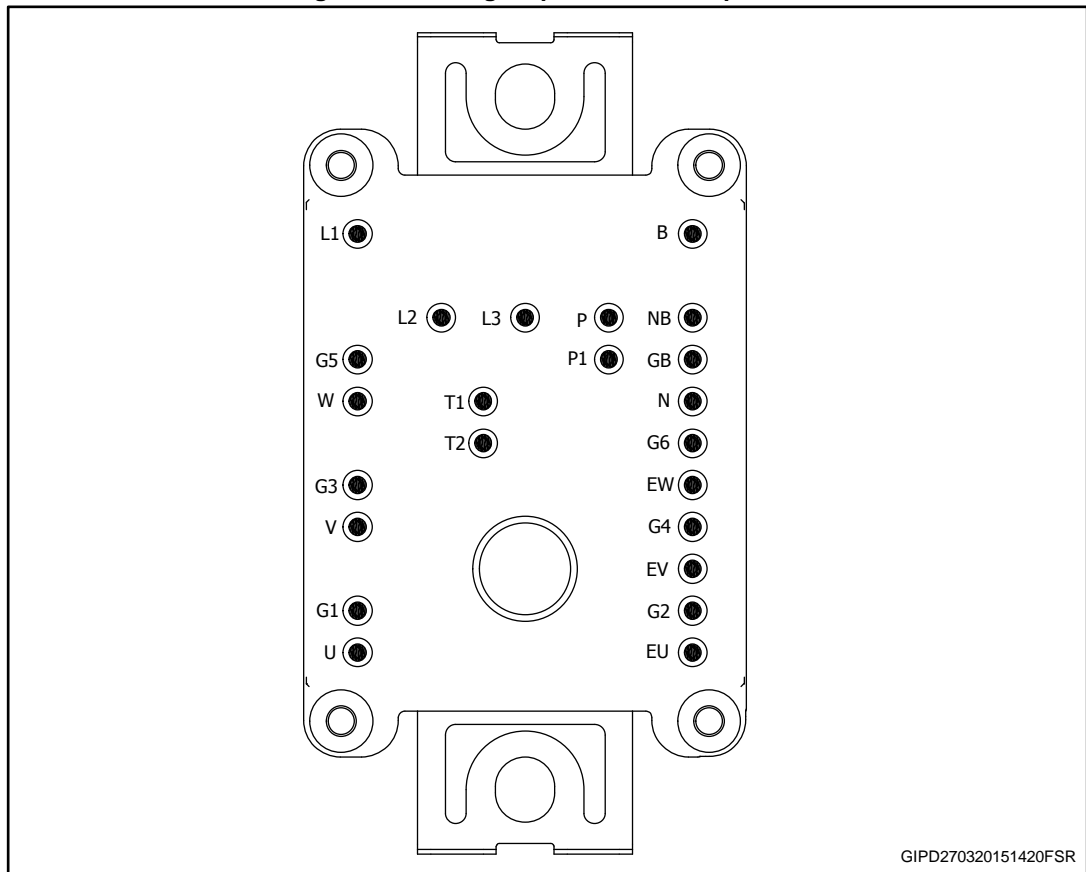


Figure 22: Package top view with CIB pinout



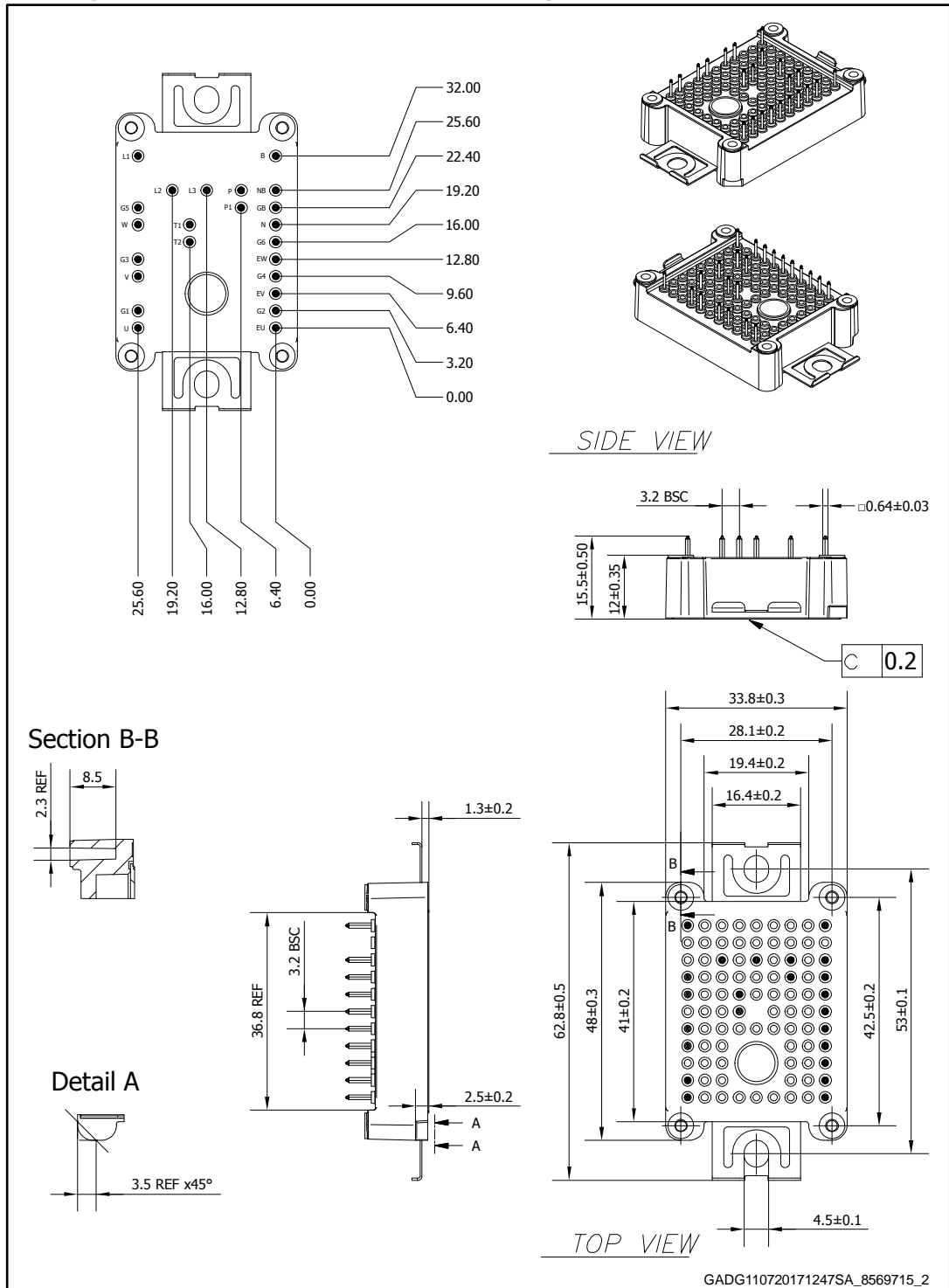
GIPD270320151420FSR

## 5 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com). ECOPACK® is an ST trademark.

# 5.1 ACEPACK™ 1 CIB solder pins package information

Figure 23: ACEPACK™ 1 CIB solder pins package outline (dimensions are in mm)



GADG110720171247SA\_8569715\_2

- The lead size includes the thickness of the lead plating material.
- Dimensions do not include mold protrusion.
- Package dimensions do not include any eventual metal burrs.



## 6 Revision history

**Table 14: Document revision history**

| Date        | Revision | Changes   |
|-------------|----------|---|
| 02-May-2016 | 1        | Initial release.  |
| 10-Mar-2017 | 2        | Added <i>Section 2: "Electrical characteristics curves" and Section 3: "Test circuits"</i> . Updated <i>Section 5.1: "ACEPACK™ 1 CIB solder pins package information"</i> .<br>Minor text changes.  |
| 26-Jul-2017 | 3        | Datasheet promoted from production data to preliminary data.<br>Modified <i>Table 2: "Absolute maximum ratings of the IGBTs, inverter stage"</i> , <i>Table 3: "Electrical characteristics of the IGBTs, inverter stage"</i> , <i>Table 6: "Absolute maximum ratings of the IGBT, brake stage"</i> , <i>Table 7: "Electrical characteristics of the IGBT, brake stage"</i> , <i>Table 4: "Absolute maximum ratings of the diode, inverter stage"</i> , <i>Table 5: "Electrical characteristics of the diode, inverter stage"</i> , <i>Table 10: "Absolute maximum ratings of the bridge rectifiers"</i> , <i>Table 11: "Electrical characteristics of the bridge rectifiers"</i> , <i>Table 12: "NTC temperature sensor, considered as stand-alone"</i> , <i>Table 13: "ACEPACK™ 1 package"</i> .<br>Modified <i>Figure 10: "IGBT thermal impedance"</i> and.<br>Modified <i>Figure 22: "Package top view with CIB pinout"</i> .<br>Modified <i>Section 5: "Package information"</i> .<br>Minor text changes. |
| 24-Aug-2017 | 4        | Updated <i>Table 3: "Electrical characteristics of the IGBTs, inverter stage"</i> , <i>Table 5: "Electrical characteristics of the diode, inverter stage"</i> , <i>Table 7: "Electrical characteristics of the IGBT, brake stage"</i> , <i>Table 9: "Electrical characteristics of the diode, brake stage"</i> , <i>Table 11: "Electrical characteristics of the bridge rectifiers"</i> , <i>Section 2: "Electrical characteristics curves"</i> .<br>Minor text changes.  |
| 05-Oct-2017 | 5        | Updated <i>Table 13: "ACEPACK™ 1 package"</i> , <i>Figure 15: "IGBT thermal impedance"</i> and <i>Figure 16: "Inverter diode thermal impedance"</i> .<br>Minor text changes.  |

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